



# Product Change Notification

**Change Notification #:** 117592 - 00  
**Change Title:** Intel® Thermal Solution BXTS15A, Retail Box, PCN 117592-00, Product Material, Retail carton artwork and text changes  
**Date of Publication:** May 15, 2020

## Key Characteristics of the Change:

Product Material

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	June 14, 2020
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## Description of Change to the Customer:

The following changes will be implemented for to the Intel® Thermal Solution BXTS15A, Retail Box

- Specific text added to the back panel of the carton in support of socket LGA1200 based desktop and workstation processors.
- Changes to the retail carton as seen in before/after images below.

## Front Panel

BEFORE

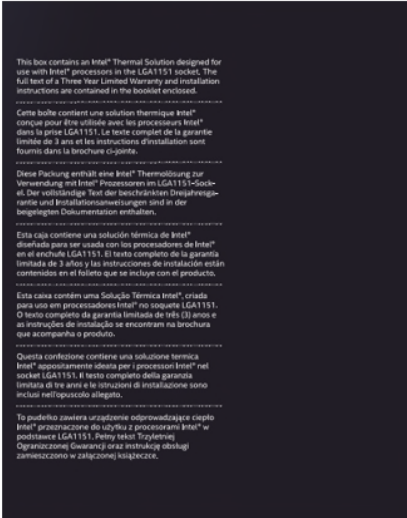


AFTER



# Right Side Panel

BEFORE



AFTER



# Left Side Panel

BEFORE



AFTER



# Top Panel

BEFORE



AFTER

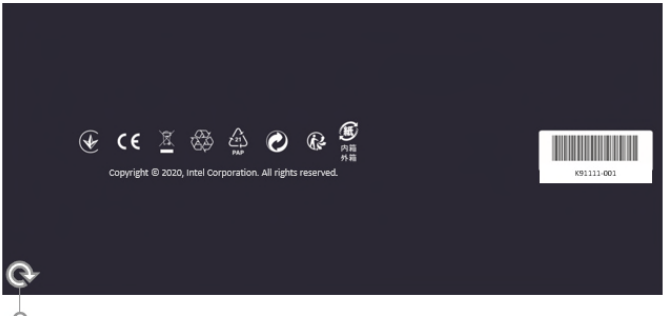


# Bottom Panel

BEFORE



AFTER



# Back Panel

BEFORE

**Intel® Thermal Solution TS15A<sup>2</sup>**



Intel® Active Thermal Solution for Intel® Core™ processor families with the LGA1151 socket

See label on side of box for product code information.

<sup>1</sup> For more information refer to the booklet enclosed.

<sup>2</sup> The actual thermal solution enclosed may differ from this image.

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内箱  
外箱

# Back Panel

## AFTER



### Customer Impact of Change and Recommended Action:

This change results in visual differences to the exterior of the retail carton, no changes are being made to the form, fit or function of the product inside.

Please contact your local Intel Field Sales representative if you have any further questions about this End of Life notice.

### Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#
Intel® Thermal Solution BXTS15A, Retail	BXTS15A944216	944216

### PCN Revision History:

**Date of Revision:**

May 15, 2020

**Revision Number:**

00

**Reason:**

Originally Published PCN



# Product Change Notification

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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